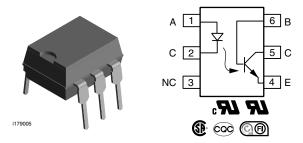


Optocoupler, Phototransistor Output, With Base Connection



LINKS TO ADDITIONAL RESOURCES

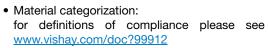


DESCRIPTION

The IL2 is an optically coupled isolated pairs employing GaAs infrared LEDs and silicon NPN phototransistor. Signal information, including a DC level, can be transmitted by the drive while maintaining a high degree of electrical isolation between input and output. The IL2 is especially designed for driving medium-speed logic and can be used to eliminate troublesome ground loop and noise problems. This coupler can be used also to replace relays and transformers in many digital interface applications such as CRT modulation.

FEATURES

- Current transfer ratio (see order information)
- Isolation test voltage 4420 V_{RMS}







RoHS

AGENCY APPROVALS

- <u>UL</u> / <u>cUL</u> 1577
- CSA
- CQC GB4943.1-2011
- CQC GB8898-2011
- FIMKO

ORDERING INFORMATION	
PART NUMBER	PACKAGE OPTION PACKAGE OPTION Option 9 Option 9
AGENCY CERTIFIED / PACKAGE	CTR (%)
UL, cUL, CSA, CQC, FIMKO	> 100
SMD-6, option 9	IL2-X009T

Note

· Additional options may be possible, please contact sales office

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)									
PARAMETER TEST CONDITION SYMBOL VALUE UNIT									
INPUT	INPUT								
Reverse voltage		V_{R}	6	V					
Forward current		I _F	60	mA					
Surge current		I _{FSM}	2.5	Α					
Power dissipation		P _{diss}	100	mW					
Derate linearly from 25 °C			1.33	mW/°C					



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
OUTPUT							
Collector emitter breakdown voltage		BV _{CEO}	70	V			
Emitter base breakdown voltage		BV _{EBO}	7	V			
Collector base breakdown voltage		BV _{CBO}	70	V			
Callector gurrent		I _C	50	mA			
Collector current	t < 1.0 ms	I _C	400	mA			
Power dissipation		P _{diss}	200	mW			
Derate linearly from 25 °C			2.6	mW/°C			
COUPLER							
Package power dissipation		P _{tot}	250	mW			
Derate linearly from 25 °C			3.3	mW/°C			
Storage temperature		T _{stg}	-40 to +150	°C			
Operating temperature		T _{amb}	-40 to +100	°C			
Junction temperature		T _j	125	°C			
Soldering temperature (1)	2.0 mm from case bottom	T _{sld}	260	°C			

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
 implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
 maximum ratings for extended periods of the time can adversely affect reliability
- (1) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP)

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT	·					
Forward voltage	I _F = 60 mA	V _F	=	1.25	1.65	V
Breakdown voltage	I _R = 10 μA	V_{BR}	6	30	-	V
Reverse current	V _R = 6.0 V	I _R	=	0.01	10	μΑ
Capacitance	V _R = 0 V, f = 1.0 MHz	Co	=	40	-	pF
Thermal resistance junction to lead		R _{thjl}	=	750	-	K/W
OUTPUT	·					
Collector emitter capacitance	V _{CE} = 5.0 V, f = 1.0 MHz	C _{CE}	=	6.8	-	pF
Collector base capacitance	$V_{CB} = 5.0 \text{ V}, f = 1.0 \text{ MHz}$	C _{CB}	=	8.5	-	pF
Emitter base capacitance	$V_{EB} = 5.0 \text{ V}, f = 1.0 \text{ MHz}$	C _{EB}	-	11	-	pF
Collector emitter leakage voltage	V _{CE} = 10 V	I _{CEO}	-	5	50	nA
Collector emitter saturation voltage	$I_{CE} = 1.0 \text{ mA}, I_{B} = 20 \mu\text{A}$	V _{CEsat}	=	0.25	-	V
Base emitter voltage	$V_{CE} = 10 \text{ V}, I_B = 20 \mu\text{A}$	VBE	=	0.65	-	V
DC forward current gain	$V_{CE} = 10 \text{ V}, I_B = 20 \mu\text{A}$	h _{FE}	200	650	1800	
DC forward current gain saturated	$V_{CE} = 0.4 \text{ V}, I_{B} = 20 \mu\text{A}$	h _{FEsat}	120	400	600	
Thermal resistance junction to lead		R _{thjl}	=	500	-	K/W
COUPLER						
Capacitance (input to output)	V _{I-O} = 0 V, f = 1.0 MHz	C _{IO}	=	0.6	-	pF
Insulation resistance	V _{I-O} = 500 V	R _S	=	10 ¹⁴	-	Ω

Note

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering
evaluation. Typical values are for information only and are not part of the testing requirements



CURRENT TRANSFER RATIO						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio (collector emitter saturated)	$I_F = 10 \text{ mA}, V_{CE} = 0.4 \text{ V}$	CTR _{CEsat}	-	170	-	%
Current transfer ratio (collector emitter)	I _F = 10 mA, V _{CE} = 10 V	CTR _{CE}	100	200	500	%
Current transfer ratio (collector base)	$I_F = 10 \text{ mA}, V_{CB} = 9.3 \text{ V}$	CTR _{CB}	-	0.25	-	%

SWITCHING CHARACTERISTICS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
NON-SATURATED						
Current time	V_{CE} = 5 V, R_{L} = 75 Ω , t_{P} measured at 50 % of output	I _F	-	4	-	mA
Delay time	V_{CE} = 5 V, R_L = 75 Ω , t_P measured at 50 % of output	t _D	-	1.7	-	μs
Rise time	V_{CE} = 5 V, R_L = 75 Ω , t_P measured at 50 % of output	t _r	-	2.6	-	μs
Storage time	V_{CE} = 5 V, R_L = 75 Ω , t_P measured at 50 % of output	t _s	-	0.4	-	μs
Fall time	V_{CE} = 5 V, R_L = 75 Ω , t_P measured at 50 % of output	t _f	-	2.2	-	μs
Propagation H to L	V_{CE} = 5 V, R_L = 75 Ω , t_P measured at 50 % of output	t _{PHL}	-	1.2	-	μs
Propagation L to H	V_{CE} = 5 V, R_L = 75 Ω , t_P measured at 50 % of output	t _{PLH}	-	2.3	-	μs
SATURATED	·					
Current time	$V_{CE} = 0.4 \text{ V}, R_L = 1.0 \text{ k}\Omega, \ V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	I _F	-	5	-	mA
Delay time	$V_{CE} = 0.4 \text{ V}, R_L = 1.0 \text{ k}\Omega, \ V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	t _D	-	1	-	μs
Rise time	$V_{CE} = 0.4 \text{ V}, R_L = 1.0 \text{ k}\Omega, V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	t _r	-	2	-	μs
Storage time	$V_{CE} = 0.4 \text{ V}, R_L = 1.0 \text{ k}\Omega, \ V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	t _S	-	5.4	-	μs
SATURATED	·					
Fall time	$V_{CE} = 0.4 \text{ V}, R_L = 1.0 \text{ k}\Omega, \ V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	t _f	-	13.5	-	μs
Propagation H to L	$V_{CE} = 0.4 \text{ V}, R_L = 1.0 \text{ k}\Omega, \ V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	t _{PHL}	-	5.4	-	μs
Propagation L to H	$V_{CE} = 0.4 \text{ V}, R_L = 1.0 \text{ k}\Omega, \ V_{CL} = 5 \text{ V}, V_{TH} = 1.5 \text{ V}$	t _{PLH}	-	7.4	-	μs

COMMON MODE TRANSIENT IMMUNITY						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Common mode rejection output high	$V_{CM} = 50 V_{P-P}, R_L = 1 k\Omega, I_F = 10 mA$	CM _H	-	5000	-	V/µs
Common mode rejection output low	$V_{CM} = 50 V_{P-P}, R_L = 1 k\Omega, I_F = 10 mA$	CM _L	-	5000	-	V/µs
Common mode coupling capacitance		C _{CM}	-	0.01	-	pF



SAFETY AND INSULATION RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		40 / 100 / 21	
Comparative tracking index		CTI	175	
Maximum rated withstanding isolation voltage	t = 1 min	V _{ISO}	4420	V_{RMS}
Maximum transient isolation voltage		V _{IOTM}	10 000	V _{peak}
Maximum repetitive peak isolation voltage		V _{IORM}	890	V _{peak}
Isolation resistance	V _{IO} = 500 V, T _{amb} = 25 °C	R _{IO}	≥ 10 ¹²	Ω
Isolation resistance	$V_{IO} = 500 \text{ V}, T_{amb} = 100 ^{\circ}\text{C}$	R _{IO}	≥ 10 ¹¹	Ω
Output safety power		P _{SO}	400	mW
Input safety current		I _{SI}	275	mA
Safety temperature		T _S	175	°C
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Insulation thickness		DTI	≥ 0.4	mm

Note

• As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits



TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

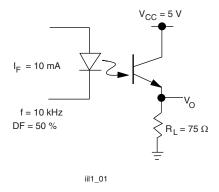


Fig. 1 - Non-Saturated Switching Schematic

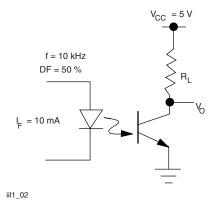


Fig. 2 - Saturated Switching Schematic

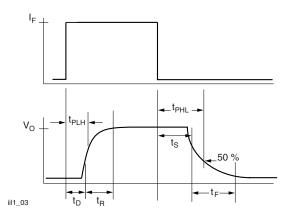


Fig. 3 - Non-Saturated Switching Timing

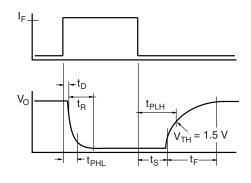


Fig. 4 - Saturated Switching Timing

iil1_04

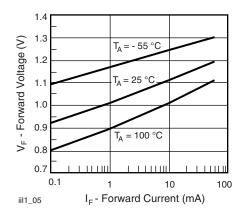


Fig. 5 - Forward Voltage vs. Forward Current

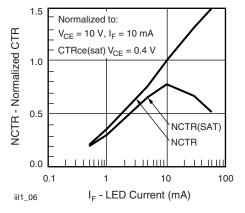


Fig. 6 - Normalized Non-Saturated and Saturated CTR vs. LED Current



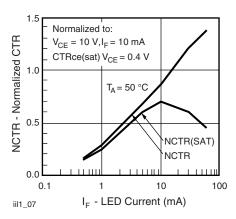


Fig. 7 - Normalized Non-Saturated and Saturated CTR vs. LED Current

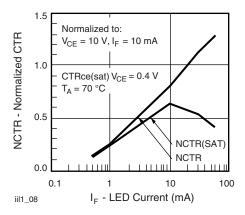


Fig. 8 - Normalized Non-Saturated and Saturated CTR vs. LED Current

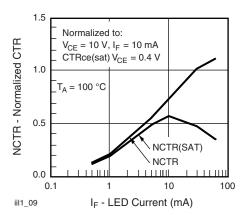


Fig. 9 - Normalized Non-Saturated and Saturated CTR, $T_{amb} = 100\ ^{\circ}\text{C}$ vs. LED Current

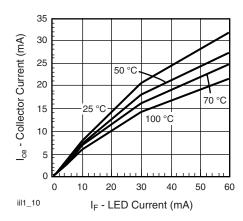


Fig. 10 - Collector Emitter Current vs. Temperature and LED Current

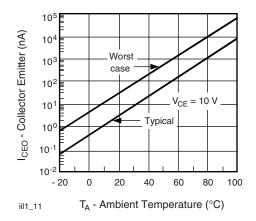


Fig. 11 - Collector Emitter Leakage Current vs. Temperature

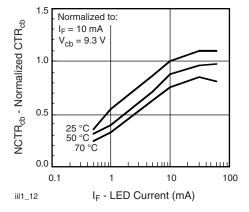


Fig. 12 - Normalized CTR_{cb} vs. LED Current and Temperature

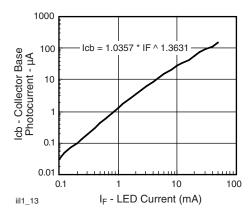


Fig. 13 - Collector Base Photocurrent vs. LED Current

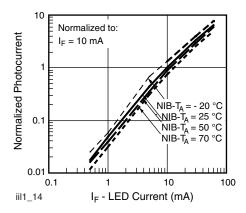


Fig. 14 - Normalized Photocurrent vs. I_F and Temperature

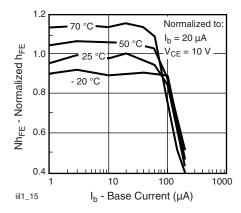


Fig. 15 - Normalized Non-Saturated h_{FE} vs. Base Current and Temperature

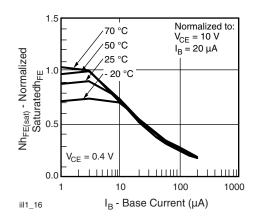


Fig. 16 - Normalized Saturated h_{FE} vs. Base Current and Temperature

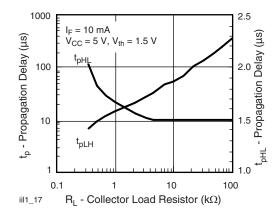
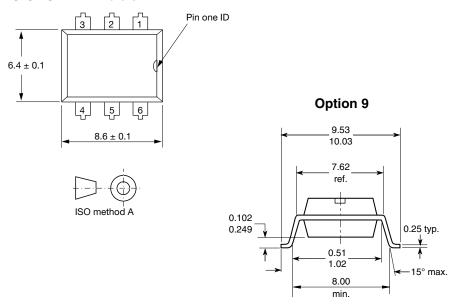


Fig. 17 - Propagation Delay vs. Collector Load Resistor



PACKAGE DIMENSIONS in millimeters





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